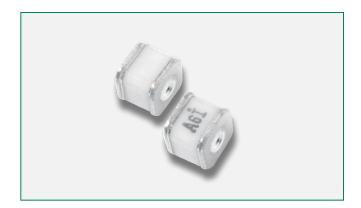


SH Series









Agency Approvals

AGENCY	AGENCY FILE NUMBER				
7U	Pending				
71	E320116				

Two Electrode GDT Graphical Symbol



Additional Information







Resources



Description

The Littelfuse SH Gas Discharge Tubes (GDT) series provides high levels of protection against fast rising transients caused by lightning disturbances. It has a surge rating of 5kA, 8/20µs. Offered in a Squared Surface Mount package, which helps to make pick and place on PCB process easier.

This GDT series is perfectly suited for broadband equipment applications. The GDT's low off-state capacitance is compatible with high bandwidth applications and this capacitance loading value does not vary if the voltage across the GDT changes.

The Littelfuse SH Gas Discharge Tube (GDT) series are specifically designed for protection of electrical, multimedia, and communication equipment against over voltage transients in surface mount assembly applications.

Features

- Excellent response to fast rising transients
- GHz working frequency
- 5kA, 8/20µs surge capability as defined by IEC 61000-4-5 2nd Edition
- UL recognized

- Offered with squared body package
- Non-Radioactive
- Ultra Low capacitance (<0.7pF)
- Lead-free and RoHS compliant

Applications

- CATV equipment
- Antennas
- RS 485
- Telecom Base Station
- Power Supply AC Main
- G.fast
- EV power Charging
- Inverter/Variable Frequency Drivers (VFDs)

- IEEE 802.3 compliant Ethernet interfaces
- Broad Band equipment
- xDSL, ADSL, ADSL2, VDSL, and VDSL2
- Medical Electronics
- Test Equipment
- General Telecom Equipment
- Renewable Energy



Electrical Characteristics

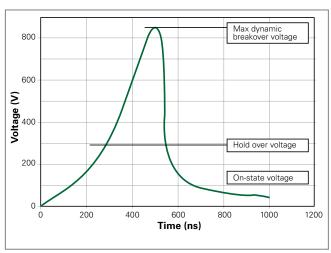
	Component Specifications (at 25°C)					Life Ratings								
Part	DC	Breakdo in Volts (@100V/s		lmp Break	mum ulse -down :age	Maximum Impulse Discharge Current (8/20µs)	Insulation Resistance	Capaci- tance (@1MHz)	Impulse Discharge Current (8/20µs)	AC Dischage Current (50Hz, 1sec)	AC Dischage Current (9 Cycles @50Hz)	DC Holdover Voltage (<150ms)*	Impulse Life (10/1000µs) (100A)	
Number	MIN	TYP	MAX	@100V/µs	1000V/µs	1 Time	MIN	MAX	MAX	MIN	MIN		MIN	
SH75	60	75	90	600	700		_	1GΩ					52V	
SH90	72	90	108	600	700			@50V					52V	
SH145	116	145	174	600	700					40.01			52V	
SH230	186	230	276	600	700					10 Shots @			80V	
SH250	200	250	300	600	700	CLA	1GΩ	0.7-4	(5kA)		154	135V	300	
SH300	240	300	360	650	800	- 6kA -	- 6KA	@100V	0.7pf		5A	15A	135V	Shots
SH350	280	350	420	750	900				1 Shot at 6kA**			135V		
SH400	360	400	480	850	1000					UKA			135V	
SH470	376	470	564	900	1100		1GΩ					150V		
SH600	480	600	720	1000	1200		@250V					150V		

Note:

Product Characteristics

Materials	Device Tin Plated 17.5 ± 12.5 Microns Construction: Ceramic Insulator		
Storage and Operational Temperature	-40 to +90°C		

Voltage Vs. Time Characteristic



Note: Tested per 1kV/µs waveform

Typical Insertion Loss

@1.0GHz :	= 0.08dB
@1.4GHz :	= 0.16dB
@1.8GHz :	= 0.26dB
@2.0GHz	= 0.33dB
@2.4GHz	= 0.47dB
@2.8GHz	= 0.59dB
@3.1GHz	= 0.70dB
@3.5GHz	= 0.89dB
@4.0GHz	= 1.24dB

 $\label{eq:Note:Insertion} \textbf{Note: Insertion data for customer reference only, application testing needed for verification.}$

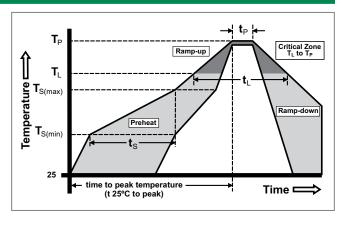
^{*} Reference REA PE-80, 0.2A, tested to ITU-T Rec K.12 and REA PE 80 <150 ms.

^{**} DC spark-over may exceed \pm 25% after discharge, but will continue to protect without venting



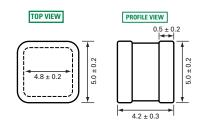
Soldering Parameters - Reflow Soldering (Surface Mount Devices)

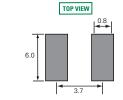
Reflow Co	ndition	Pb – Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (Min to Max) (t _s)	60 – 180 secs		
Average ra	amp up rate (LiquidusTemp k	3°C/second max		
T _{S(max)} to T _L	- Ramp-up Rate	5°C/second max		
Reflow	-Temperature (T _L) (Liquidus)	217°C		
nellow	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	erature (T _P)	260+ ^{0/-5} °C		
Time with	in 5°C of actual peak ure (t _p)	10 – 30 seconds		
Ramp-dov	vn Rate	6°C/second max		
Time 25°C	to peakTemperature (T _P)	8 minutes Max.		
Do not exc	ceed	260°C		
Do not exc	ceea	200°C		



Product Dimensions

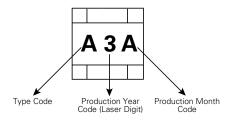
Dimensions in millimeters





Recommended Soldering Pad Layout

Product Marking

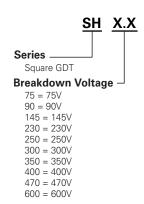


Type Code					
SH75					
SH90					
SH145					
SH230					
SH250					
SH300					
SH350					
SH400					
SH470					
SH600					

Month Code					
Α	January				
В	February				
С	March				
D	April				
E	May				
F	June				
G	July				
Н	August				
ı	September				
J	October				
K	November				
L	December				



Part Numbering System and Ordering Information

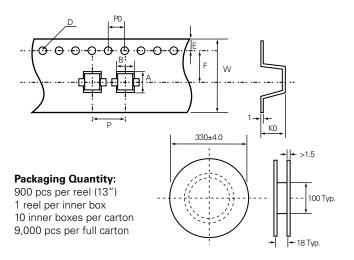


Taping and Reel Specifications

Taping

Unit = mm

Item	Spec	Item	Spec	
Р	12.0±0.1	D	Ø1.55±0.05	
P0	4.0±0.1	W	16.0±0.3	
Α	5.4±0.1	K0	5.4±0.1	
В	4.6±0.1	t	0.5±0.05	



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